

Features

- On-chip Hall sensor with two different sensitivity and hysteresis settings for AH276
- Built-in protecting diode only for chip reverse power connecting
- -20°C to 85°C operating temperature
- Lead Free Package: SIP-4L
- SIP-4L: Available in "Green" Molding Compound (No Br. Sb)
- Lead Free Finish/RoHS Compliant (Note 1)

General Description

AH276 are integrated Hall sensors with output drivers, mainly designed for electronic commutation of brush-less DC Fan. This IC internally includes the regulator, protecting diode, Hall plate, amplifier, comparator, and a pair of complementary open-collector outputs (DO, DOB).

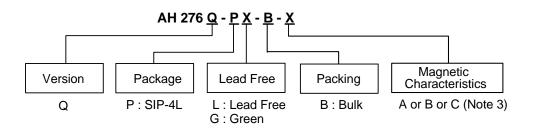
While the magnetic flux density (B) is larger than operate point (Bop), DO will turn on (low), and meanwhile DOB will turn off (high). Each output is latched until B is lower than release point (Brp), and then DO, DOB transfer each state.

For DC fan application, sometimes need to test power reverse connection condition. Internal diode only protects chip-side but not for coil-side. If necessary, add one external diode to block the reverse current from coil-side.

Applications

- Dual-coil Brush-less DC Motor
- Dual-coil Brush-less DC Fan
- Revolution Counting
- Speed Measurement

Ordering Information



		Package	Packaging		Bulk	Magnetic
	Device	Code	(Note 2)	Quantity	Part Number Suffix	Characteristics
Pb	AH276Q-PL-B-A	Р	SIP-4L	1000	-B	А
Pb	AH276Q-PL-B-B	Р	SIP-4L	1000	-B	В
Pb	AH276Q-PL-B-C	Р	SIP-4L	1000	-B	С
0,	AH276Q-PG-B-A	Р	SIP-4L	1000	-B	Α
0,	AH276Q-PG-B-B	Р	SIP-4L	1000	-B	В
0,	AH276Q-PG-B-C	Р	SIP-4L	1000	-B	С

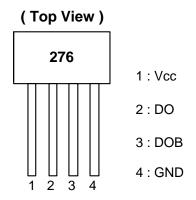
Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/products/lead_free.html

 Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

3. Please refer to page 4 (Magnetic Characteristics table).



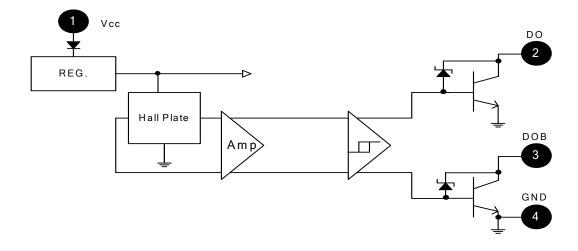
Pin Assignment



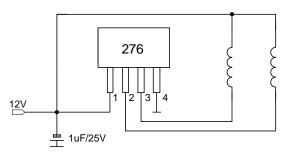
Pin Descriptions

Pin Name	P/I/O	Pin#	Description
Vcc	Р	1	Power Supply Input
DO	0	2	Output Pin
DOB	0	3	Output Pin
GND	Р	4	Ground

Block Diagram



Typical Application Circuit

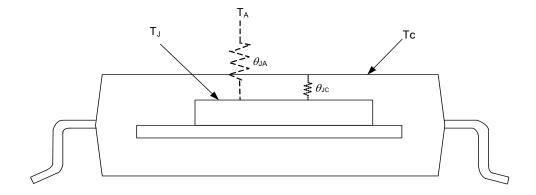


Brush-less DC Fan

Absolute Maximum Ratings (@ TA=25°C)

Symbol	Characteristics		Rating	Unit
V _{CC}	Supply Voltage		20	V
V_{RCC}	Reverse V _{CC} Polarity Volta	ge	-20	V
В	Magnetic Flux Density		Unlimite	ed
	Out = 1 " = 2" = 2 = 2	Continuous	0.4	
lo	Output "on" current (Note 4)	Hold	0.5	Α
		Peak (Start Up)	0.7	
Ts	Storage Temperature Range	ge	-65~+150	°C
P _D	Package Power Dissipation	n (SIP-4L)	550	mW
TJ	Maximum Junction Tempe	rature	150	°C
θ _{JC}	Thermal Resistance (SIP-4	ŀL)	227	°C/W

Notes: 4. P_D shall be within Safety Operation Area.





Recommended Operating Conditions

Symbol	Characteristic	Conditions	Min	Max	Unit
V _{cc}	Supply Voltage (Note 5)	Operating	3.5	20	V
T _A	Operating Ambient Temperature	Operating	-20	85	°C

Notes: 5. The output DO/DOB is switching as magnetic field change (S>300G, N<-300G).

Electrical Characteristics (T_A=+25°C)

Symbol	Characteristic	Conditions	Min	Тур.	Max	Unit
Vz	Output Zener Breakdown	(Note 6)	-	35	-	V
Vce(sat)	Output Saturation Voltage	Vcc=14V, I _L =400mA	-	0.6	0.9	V
Icex	Output Leakage Current	Vce=14V, Vcc=14V	-	<0.1	10	μΑ
Icc	Supply Current	Vcc=20V, Output Open	7	16	25	mA

Notes: 6. Vz is a typical value for design reference. Vz will vary with different coils design.



Magnetic Characteristics (T_A=+25°C, V_{CC}=14V, Note 7)

A grade

Symbol	Characteristic Min Typ.		Тур.	Max	Unit	
Вор	Operate Point	10	-	50	Gauss	
Brp	Release Point	-50	-	-10	Gauss	
Bhy	Hysteresis	-	75	-	Gauss	

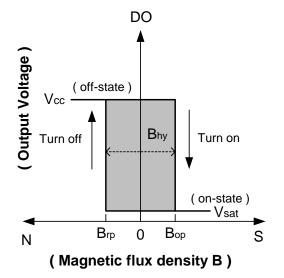
B grade

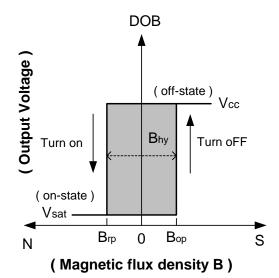
Symbol	Characteristic	Min	Тур.	Max	Unit
Вор	Operate Point	5	-	70	Gauss
Brp	Release Point	-70	-	-5	Gauss
Bhv	Hysteresis	-	75	-	Gauss

C grade

Symbol	Characteristic	Min	Тур.	Max	Unit
Вор	Operate Point	-	-	100	Gauss
Brp	Release Point	-100	-	-	Gauss
Bhy	Bhy Hysteresis		75	-	Gauss

Notes: 7. Magnetic characteristics are for design information, which will vary with supply voltage, operating temperature and after soldering.

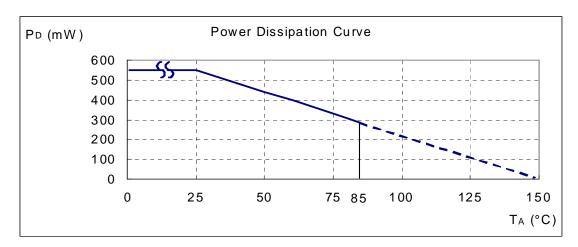




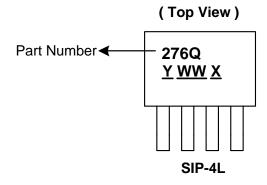


Performance Characteristics

T _A (°C)	25	50	60	70	80	85	90	95	100
P _D (mW)	550	440	396	352	308	286	264	242	220
T _A (°C)	105	110	115	120	125	130	135	140	150
P _D (mW)	198	176	154	132	110	88	66	44	0



Marking Information



Y: Year: 0~9

WW: Week: 01~52, "52" represents

52 and 53 week

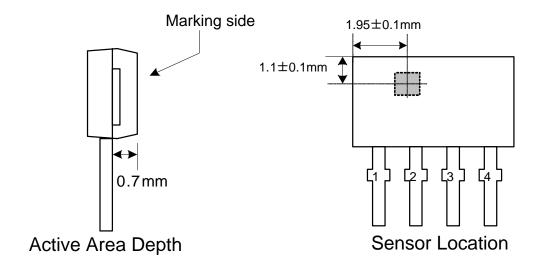
X: Internal Code: a~z: Lead Free

A~Z: Green

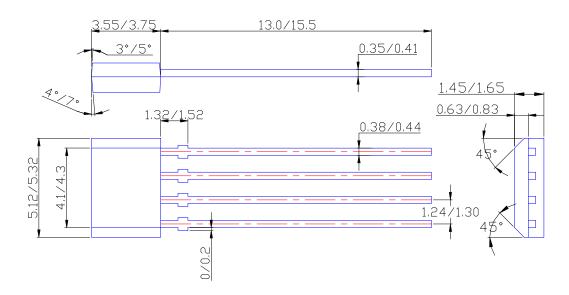


Package Information (All Dimensions in mm)

(1) Package type: SIP-4L



Package Dimension





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